

## **Product Change Notification / GBNG-30ZMTP819**

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02-Jul-2020

# **Product Category:**

Memory

## **PCN Type:**

Manufacturing Change

# **Notification Subject:**

CCB 4284 Initial Notice: Qualification of GTK as a new assembly site for selected SST39VF640xxx device family available in 48L TSOP (12x20mm) package.

## **Affected CPNs:**

GBNG-30ZMTP819\_Affected\_CPN\_07022020.pdf GBNG-30ZMTP819\_Affected\_CPN\_07022020.csv

## **Notification Text:**

PCN Type: Manufacturing Change

Microchip Parts Affected:Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:** Qualification of GTK as a new assembly site for selected SST39VF640xxx device family available in 48L TSOP (12x20mm) package.

#### Pre Change:

Assembled at LPI using 8340 die attach and G700 molding compound material.

#### Post Change:

Assembled at GTK using EN-4900GC die attach and G600F molding compound material.

### **Pre and Post Change Summary:**

	Pre Change	Post Change
Assembly Site	Lingsen Precision Industries, LTD. (LPI)	Greatek Electronic Inc. (GTK)
Wire material	Au	Au
Die attach material	8340	EN-4900GC
Molding compound material	G700	G600F
Lead frame material	C7025	C7025

Impacts to Data Sheet: None

Change Impact:None

#### Reason for Change:

To improve on-time delivery performance by qualifying GTK as a new assembly site.

### **Change Implementation Status:**

In Progress

#### **Estimated Qualification Completion Date:**

December 2020

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date quided in the final PCN customers may receive pre and post change parts.

### **Time Table Summary:**

	July 2020			December 202			20			
Workweek	27	28	29	30	31		49	50	51	52
Initial PCN Issue Date	Χ									
Qual Report Availability									Χ	
Final PCN Issue Date									Χ	

### Method to Identify Change:

Traceability code

#### **Qualification Plan:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Plan.

#### **Revision History:**

July 02, 2020: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.	
Attachments:	
PCN_GBNG-30ZMTP819_Qual_Plan.pdf	
Please contact your local Microchip sales office with questions or concerns regarding this notification.	
Terms and Conditions:	
If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.	
If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.	

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### Affected Catalog Part Numbers (CPN)

SST39VF6401B-70-4C-EKE

SST39VF6402B-70-4C-EKE

SST39VF6401B-70-4I-EKE-100

SST39VF6401B-70-4I-EKE-101

SST39VF6401B-70-4I-EKE

SST39VF6402B-70-4I-EKE

SST39VF6401B-70-4I-EKE-MCL

SST39VF6401B-70-4I-EKE-TZ009

SST39VF6401B-70-4C-EKE-T

SST39VF6402B-70-4C-EKE-T

SST39VF6401B-70-4I-EKE-T

Date: Thursday, July 02, 2020